

ADS8364/65MEVM

This user's guide describes the characteristics, operation, and use of the ADS8364/65MEVM 16-bit, parallel analog-to-digital converter evaluation module (EVM). A complete circuit description, a schematic diagram, and bill of materials is included.

Contents 1 2 3 Analog Interface 2 4 5 Power Supplies 6 6 EVM Operation 6 7 8 **List of Figures** 1 2 3 **List of Tables** 1 2 3 4 JP1 Pinout 6

1 EVM Overview

1.1 Features

- Full-featured evaluation board for the ADS8364 and ADS8365 250-kHz, 16-bit, 6-channel, simultaneous-sampling, analog-to-digital converter
- Analog inputs can be configured as single-ended or differential
- Modular design allows direct connection to various DSP platforms through the 5-6K and HPA-MCU Interface Boards
- Built-in reference

5

6

· High-speed parallel interface



2 Introduction

The ADS8364 and ADS8365 are high-speed, low-power, 6-channel, 16-bit A/D converters that operate from independent +5-V Avdd and Dvdd supplies. Internal buffer circuits powered from 3.3-V to 5.5-V BVdd supplies allow for mixed logic level operation without additional level translation.

The six input channels contain fully differential sample-and-hold circuits which are divided into three pairs (A, B, and C). Each channel pair has a hold signal (HOLDA, HOLDB, and HOLDC) which, when strobed together, provides simultaneous sampling on all six analog inputs. The devices accept analog input voltages in the range of -V_{REF} to +V_{REF}. The parts also accept bipolar input ranges when a level shift circuit is used in the analog front-end circuitry (see Figure 1).

Conversion time for the ADS8364 and ADS8365 is 3.2 µs when a 5-MHz external clock is used. The corresponding acquisition time is 800 ns. To achieve maximum output rate (250 kHz per channel, effective 1.5-MSPS throughput max), the read function can be performed during the start of the next conversion.

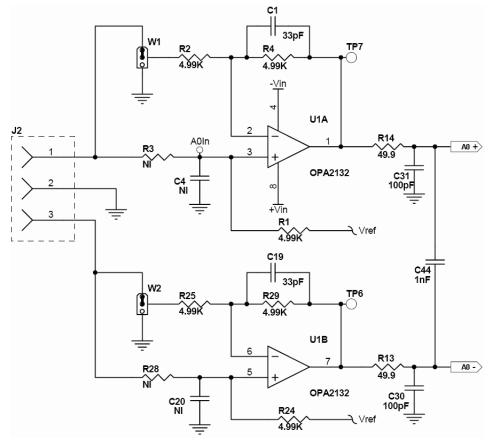
3 **Analog Interface**

The analog input to the EVM is divided in two parts. Connector J4 provides access to input channels A0 and A1 through two different amplifier circuit configurations. The input buffer configuration of channel A0 presents a typical front-end circuit for the A/D converter. Its function is to provide level and impedance adaptation of the input signal. The input to channel A1 is a bipolar configuration using the INA159 to accommodate ±10-V input signals. Connector J3 provides access to the remaining analog input channels through simple R/C filters.

3.1 Analog Input - Channel A0

The analog input to the ADS8364/65MEVM board for channel A0 is composed of the dual OPA2132 operational amplifier and its associated circuitry as shown in Figure 1. The OPA2132 is powered from the ±12-V analog supply, and arranged as an inverting amplifier with a gain of 1. The internal +2.5-V reference voltage of the ADS8364 or ADS8365 is applied to the noninverting input of the OPA2132 to provide input bias.





NOTE: Components marked NI are NOT INSTALLED.

Figure 1. Channel A0 Input Circuit

This configuration allows single-ended signals of ± 2.5 V (+5 Vpp) to be applied to either input of channel A0 (J2 pin 1 or 3 referenced to pin 2). The input also can be applied to connector J4 (not shown) pins 2 or 4, referenced to analog ground.

3.2 Bipolar Input to Channel A0

By changing components and setting the appropriate jumper, it is possible to configure the input buffer to accept bipolar input voltages. Table 1 is related to the schematic presented in Figure 1 and represents just a few of the possible input configurations.

Input Voltage R3 R2 R1 R4 W2 **R28 R25 R24 R29** W1 Refer to Figure 1 Default open $5 k \Omega$ $5k\Omega$ $5~\mathrm{k}\Omega$ 1-2 0 - +50 - 2.5 $5~\text{k}\Omega$ $5~\text{k}\Omega$ $5~\mathrm{k}\Omega$ 2-3 open **- 2.5 - +2.5** 20 kΩ $4~\text{k}\Omega$ 20 kΩ $4~\text{k}\Omega$ 2-3 -5 - +520 kΩ $4~\text{k}\Omega$ 10 $k\Omega$ $2 k\Omega$ 2-3 -10 - +1020 kΩ $4 \text{ k}\Omega$ 5 k Ω $1 \text{ k}\Omega$ 2-3

Table 1. Typical Analog Input Buffer Circuit Values



The output from the buffer stage in each case applies 0-5 V to the CHA0(+) input when the applied signal is connected to J2 pin 1 or J4 pin 2. The applied signal is directed to the CHA0(-) input when connected via J2 pin 3 or J4 pin 4.

When operating the ADS836x with single-ended signals, it is important to keep the unused ADC input biased to +2.5 V. This is easily accomplished on the EVM by changing the components associated with either the inverting or noninverting input only, leaving the default component values shown in Table 1 on the unused input. For example, to achieve a bipolar input range of ±10 V on CHA0(+), use the component values shown for R1–R4 and move the shunt on W2 position 2-3. Components R24, R25, R28, and R29 and the shunt on W1 should remain in the default conditions shown in Table 1.

3.3 Analog Input – Channel A1

The analog input to the ADS8364/65MEVM board for channel A1 is composed of the INA159 difference amplifier and the associated circuitry as shown in Figure 2. The INA159 is powered from the +5-V analog supply, and arranged as a noninverting amplifier with a gain of 0.2. The internal +2.5-V reference voltage of the ADS836x is applied to both REF1 and REF2 pins of the INA159 to provide a direct ± 10 -V interface with built-in level translation to the noninverting input of channel A1.

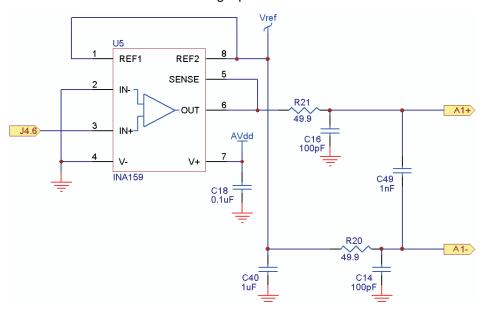


Figure 2. Channel A1 Input Circuit

3.4 Analog Inputs – Channels B0/B1 and C0/C1

The analog inputs to the remaining ADS836x input channels are routed to connector J3 and configured with simple R/C filters only. This configuration allows the EVM user to apply any customized input circuit to the data converter. Connector J3 is composed of a male/female pass-through combination of pin header and socket with industry standard 0.1-inch centers.

When the ADS8364/65MEVM is used in combination with the 5-6K Interface Board or HPA-MCU Interface Board, the DAP Signal Conditioning Board (<u>SLAU105</u>) can be used to drive the remaining input channels.

4 Digital Interface

The ADS8364/65MEVM is designed for easy interfacing to multiple control platforms. Jumper options are provided on the EVM to allow control over the state of Chip Select pin (\overline{CS}) as well as the operating mode pins (A0–A2), the Reset pin (\overline{RST}) , and the Conversion Start strobes (HOLD A, HOLDB, and HOLDC).



Jumpers W4 and W6 control the signals applied to A0, A1, A2, and \overline{CS} . In the factory default mode, W6 is closed by means of a shunt jumper. The Ax and \overline{CS} pins are controlled by the signals applied to J5 (top or bottom side). When used with either the 5-6K or HPA-MCU Interface Boards, these control signals are associated with the host processors address bus.

By removing the shunt jumper located at W6, the A0, A1, and A2 pins are controlled by shunt jumpers placed on W4. The \overline{CS} pin is routed to J5.1, which requires the application of an active-low Chip Select signal. A simple shunt jumper placed across J5 pins 1-2 can be used to force the \overline{CS} pin to ground if desired.

4.1 Parallel Control

Samtec part numbers SSW-110-22-F-D-VS-K and TSM-110-01-T-DV-P provide a convenient 10-pin, dual-row, header/socket combination at J5 (Table 2). This header/socket provides access to the digital control pins of the EVM. Consult Samtec at www.samtec.com or 1-800-SAMTEC-9 for a variety of mating connector options.

Pin Number	Signal	Description
J5.1	DC_CSa	Daughter Card Chip Select – active-low signal used to access the EVM
J5.3	DC_AWE	Write Strobe – signal not used on the ADS8364/65M EVM
J5.5	DC_ARE	Read Strobe – active-low signal used to access parallel data
J5.7	EVM_A0	EVM Address line 0 – used with U3 to control A0
J5.9	EVM_A1	EVM Address line 1 – used with U3 to control A1
J5.11	EVM_A2	EVM Address line 2 – used with U3 to control A2
J5.13	EVM_A3	EVM Address line 3 – used with U3 and U6 to control CS
J5.15	EVM_A4	EVM Address line 4 – not used
J5.17	DC_TOUT	Timer Input – optional CLK input used with W8
J5.19	DC_INTa	Interrupt Output to Host Processor – connects to the ADC EOC pin

Table 2. Header/Socket Combinations at J5

4.2 Parallel Data

The ADS8364/65MEVM uses Samtec part numbers SSW-116-22-F-D-VS-K and TSM-116-01-T-DV-P to provide a convenient 16-pin, dual-row header/socket combination at J6. This header/socket combination provides access to the parallel data pins of the ADS7864. Data line D0 is connected to J6 pin 1. Data lines 1–15 are located on pins 3–31, respectively. Even pin numbers 2–32 are connected to digital ground.

4.3 GPIO/Control Options

Samtec part numbers SSW-110-22-F-D-VS-K and TSM-110-01-T-DV-P provide a 10-pin, dual-row, header/socket combination at J1 to facilitate general-purpose input/output (GPIO) control options to the ADS836x device installed on the EVM. Table 3 describes the functions and pinout of J1.



Table 3. J1 Pinout and Functions

Pin Number	Signal	Description
J1.1	NAP	Controls power-down options on the ADS8365 (only) using the NAP input pin
J1.3	ADD	Controls read options, when HI, address information can be read from the chip
J1.5	HOLD_C#	Active-low signal HOLDC used to start a conversion on ADC channel pair C
J1.7	HOLD_B#	Active-low signal HOLDB used to start a conversion on ADC channel pair B
J1.9	HOLD_A#	Active-low signal HOLDA used to start a conversion on ADC channel pair A
J1.11	RESET#	Active-low signal RESET used to place the ADS7864's FIFO in reset state
J1.13	NA	Unused on the ADS8364/65MEVM
J1.15	NA	Unused on the ADS8364/65MEVM
J1.17	DC_TOUTa	Used with W10 to allow host processor timer control of HOLDx
J1.19	NA	Unused on the ADS8364/65MEVM

5 Power Supplies

The ADS8364/65MEVM board requires +5 VDC for the both the analog and digital section of the ADC. The supply (+Va and +Vd) can range from +4.75 VDC to +5.25 VDC. The internal buffer can be powered through the BVdd input voltage and can range from 2.7 VDC to 5.5 VDC. Because the EVM is designed to work with the 5-6K and HPA-MCU Interface Boards, JP1 provides direct connection to the common power bus described in SLAU104.

Table 4 shows the pinout of JP1:

Table 4. JP1 Pinout

Signal		umber	Signal	
+VA (positive input buffer supply)	1	2	-VA (negative input buffer supply)	
+5VA (+Va to the ADS8364)	3	4	-5VA (Unused)	
DGND	5	6	AGND	
+1.8VD (Unused)	7	8	+VD1 (Unused)	
+3.3VD (used with W5 for support circuitry)	9	10	+5VD (+5V to pin 22 of the ADS8364 and pin 22 of the ADS8365)	

Alternate power sources can be applied via various test points located on the EVM. See the schematic at the end of this document for details. Note – while filters are provided for all power supply inputs, optimal performance of the EVM requires a clean, well-regulated power source.

5.1 Reference Voltages

The ADS8364/65MEVM is configured to use its internal reference through jumper W3 (see schematic for details). If an external reference is desired, the shunt jumper on W3 should be moved to cover pins 1-2; the external reference source can be applied to the test point labeled TP10 referenced to TP12. The internal +2.5-V reference is still connected to the input buffer U1 in this case to ensure proper mid-point biasing to channel A1.

6 EVM Operation

The analog input swing is 5 Vpp, centered on a +2.5-V internal or external reference. The installed device accepts bipolar input ranges when a level shift circuit is used in the analog front-end circuitry. For information on various circuit configurations, see section 3.2 of this document or section 12 of *Op-Amps for Everyone* (SLOD006).

Once power is applied to the EVM, the analog input source can be connected directly to J3 or J4 (top or bottom side) or through optional amplifier and signal-conditioning modules using the 5-6K and HPA-MCU Interface Boards. The analog input level should not exceed 5 Vp-p. The analog input range is from \pm Vref (typically 2.5 VDC) centered at \pm 2.5 V.



The digital control signals can be applied directly to J1 and J5 (top or bottom side). The ADS8364/65MEVM can also be connected directly to the 5-6K Interface Board for use with a variety of C5000™ and C6000™ series DSP Starter Kits (DSK), or the HPA-MCU Interface Board for use with C2000™ Series DSPs and TMS470™ Series controllers. The Control and Data connectors are designed to allow pattern generators and/or logic analyzers to be connected to the EVM using standard ribbon-type cables on 0.1-inch centers.

The BYTE signal, which controls the output of the ADS836x when used with 8-bit controllers, can be manipulated with jumper W7. By default, W7 is closed and the BYTE pin is held low, providing data in 16-bit format. Removing the shunt at W7 asserts BYTE high by means of pullup resistor R23.

The conversion clock can be applied to J7, a BNC connector with a $50-\Omega$ terminator, or J5 as mentioned previously. Jumper W8 allows the EVM user to select the clock source. In normal operation (factory default) the shunt on jumper W8 is covering pins 2-3. To use a clock source applied to the BNC connector J7, move the shunt at jumper W8 to cover pins 1-2. In either case, the conversion clock can be monitored at TP21.

6.1 Default Jumper Locations

Table 5 provides a list of jumpers found on the EVM and their factory default conditions.

Jumper	Shunt Position	Jumper Description
W1	Pins 1-2	Controls CHA1(+) input source selection
W2	Pins 1-2	Controls CHA1(-) input source selection
W3	Pins 2-3	Controls reference source (default is internal)
W4	OPEN	3x2 Jumper to control A0, A1, A2
W5	Pins 1-2	Controls BVdd Selection
W6	Closed	Controls application of A0, A1 and A2 signals as well as the chip select input. Used in conjunction with W4.
W7	Closed	Controls BYTE input, opening W7 forces BYTE high via R23
W8	Pins 2-3	Controls application of conversion clock source via J5 or J7
W9	NA	W9 pins 2-3 are wired short on the PWB
W10	TIMER	3×3 Jumper to control HOLDx signals – timer or GPIO options available

Table 5. ADS8364/65MEVM Jumpers

7 EVM Bill of Materials, Assembly Drawing, and Schematic

7.1 Bill of Materials

Table 6 contains a complete Bill of Materials for the ADS8364/65MEVM.

Designators	Description	Manufacturer	Mfg. Part Number
C2 C3 C7 C10–C12 C18 C37–C39 C41 C45–C49 C52	0.1uF, 0603, Ceramic, X7R, 25V, 10%	TDK Corp.	C1608X7R1E104K
C35 C36 C42–C44 C53	1nF, 0603, Ceramic, COG, 50V, 5%	TDK Corp.	C1608C0G1H102J
C5 C6 C8 C9 C13 C15	10μF, 0805, Ceramic, X5R, 16V, 10%	Taiyo Yuden	EMK212BJ106KG-T
C1 C19	33pF, 0805, Ceramic, COG, 50V, 5%	TDK Corp.	C1608C0G1H330J
C22 C24	0.01μF, 0603, Ceramic, COG, 25V, 5%	TDK Corp.	C1608C0G1E103J
C16 C14 C25-C34	100pF, 0603, Ceramic, COG, 50V, 5%	TDK Corp.	C1608C0G1H101J
C50	1μF, 0603, Ceramic, X7R, 16V, 10%	TDK Corp.	C1608X7R1C105K

Table 6. ADS8364/65MEVM Bill of Materials



Table 6. ADS8364/65MEVM Bill of Materials (continued)

Designators	Description	Manufacturer	Mfg. Part Number
D1 D2	Green LED	Chicago Miniature	CMD15-21VGC/TR8
J1 J3–J5(Bottom Side)	10 Pin, Dual Row, SMT Socket (20 Pos.)	Samtec	SSW-110-22-S-D-VS
J1 J3-J5 (Top Side)	10 Pin, Dual Row, SMT Header (20 Pos.)	Samtec	TSM-110-01-T-D-V-P
J2	3 Terminal Screw Connector	On-Shore Tech.	ED555/3DS
J6 (Bottom Side)	16 Pin, Dual Row, SMT Socket (32 Pos.)	Samtec	SSW-116-22-S-D-VS
J6 (Top Side)	16 Pin, Dual Row, SMT Header (32 Pos.)	Samtec	TSM-116-01-T-D-V-P
J7	PCB Mount BNC	Amphenol	31-5329
JP1(Bottom Side)	5 Pin, Dual Row, SMT Socket (10 Pos.)	Samtec	SSW-105-22-S-D-VS
JP1 (Top Side)	5 Pin, Dual Row, SMT Header (10 Pos.)	Samtec	TSM-105-01-T-D-V-P
FB1-FB5	0805 size Ferrite Bead	TDK Corp.	MMZ2012D121B
R1 R2 R4 R24 R25 R29	4.99kΩ, 1%, 0805, .1W Resistor	Yageo Corp.	9C08052A4991FKHFT
R5–R14 R20 R21 R31 R36	49.9 Ω, 0603, 1%, 0.1W Resistor	Yageo Corp.	RC0603FR-0749R9L
R16–R19 R22 R23 R34 R35	10kΩ, 0603, 5%, 0.1W Resistor	Yageo Corp.	RC0603JR-0710KL
R26 R27	2kΩ, 0805, 0.1W Resistor	Yageo Corp.	9C08052A2001JLHFT
R15 R32	0 Ω, 0603, 0.1W Resistor	Yageo Corp.	RC0603JR-070RL
TP1-TP3 TP8 Tp9 TP10 TP20	Red Test Point Loop	Keystone	5000
AGND DGND TP12	Black Test Point Loop	Keystone	5001
TP11 TP13-TP17 TP21-TP24	SMT Test Point Loop – Shown on Silkscreen as: A0, A1, A2, RST, RD, WR, CS, CLOCK, FD, EOC	Keystone	5015
U1	OPA2132, SOIC	Texas Instruments	OPA2132UA
U2	OPA2340; DGK package	Texas Instruments	OPA2340EA
U4	ADS8364	Texas Instruments	ADS8364Y/250
U5	INA159; DGK package	Texas Instruments	INA159AIDGKR
U3	SN74CBT3257PW	Texas Instruments	SN74CBT3257PWR
U6	SN74AHC1G04	Texas Instruments	SN74AHC1G04DBVT
U7	SN74AHC125	Texas Instruments	SN74AHC125PW
W1-W3 W5 W8	3 Pin Header	Samtec	TSW-103-07-L-S
W6 W7	2 Pin Header	Samtec	TSW-102-07-L-S
W4	2×3 Header	Samtec	TSW-103-07-L-D
W10	3×3 Header	Samtec	TSM-103-07-L-T
C4 C17 C20 C21 C23 C51 R3 R28 R33 W9	Not Installed		



7.2 Assembly Drawing

Figure 3 shows the top layer of the ADS8364/65MEVM and provides quick access to component designator found on the PWB. Complete Gerber files are available on request.

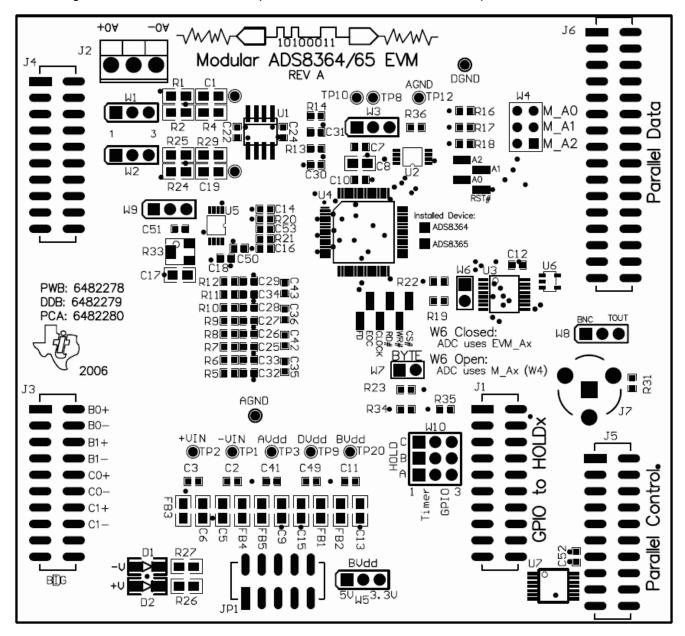
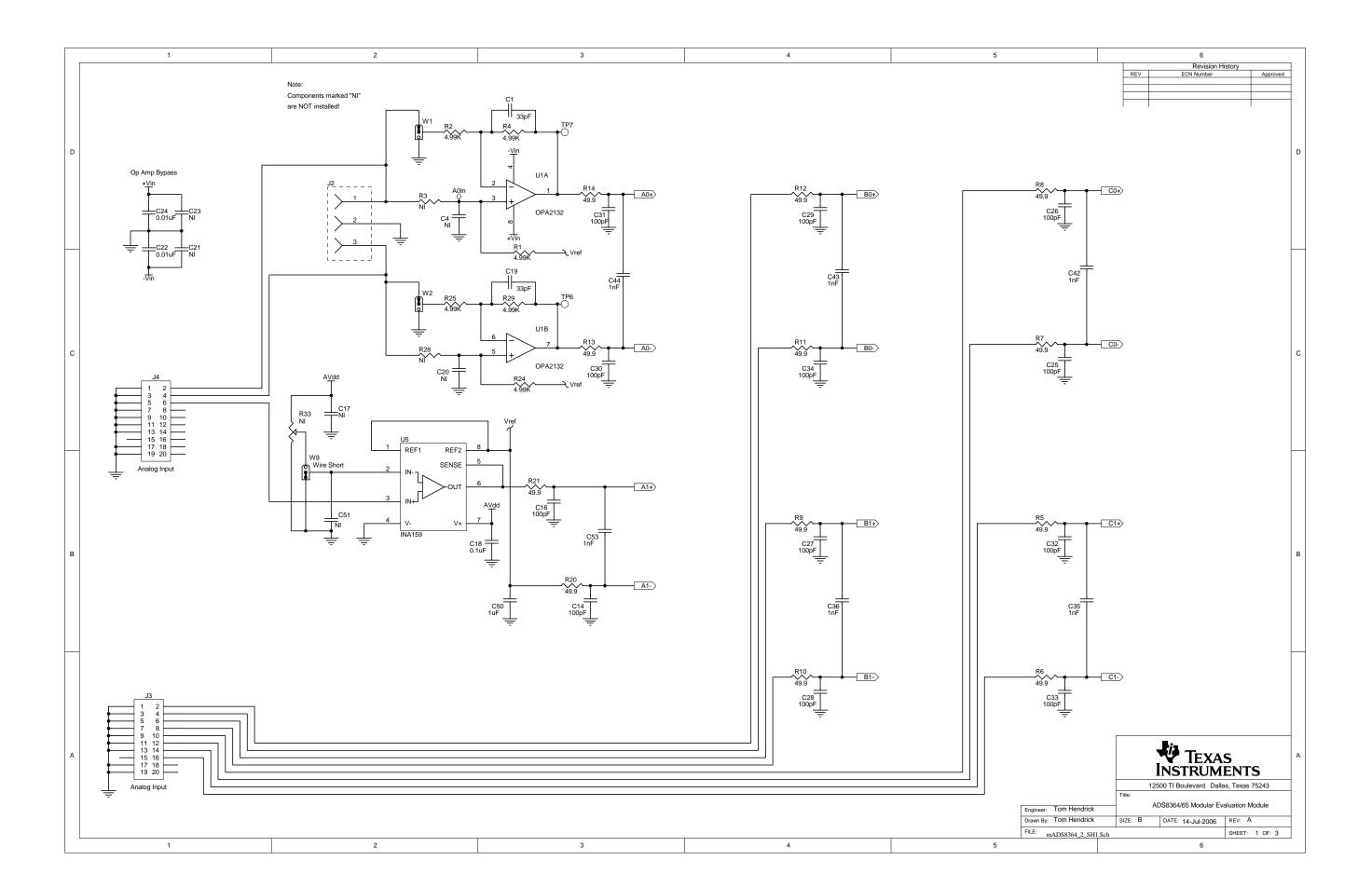
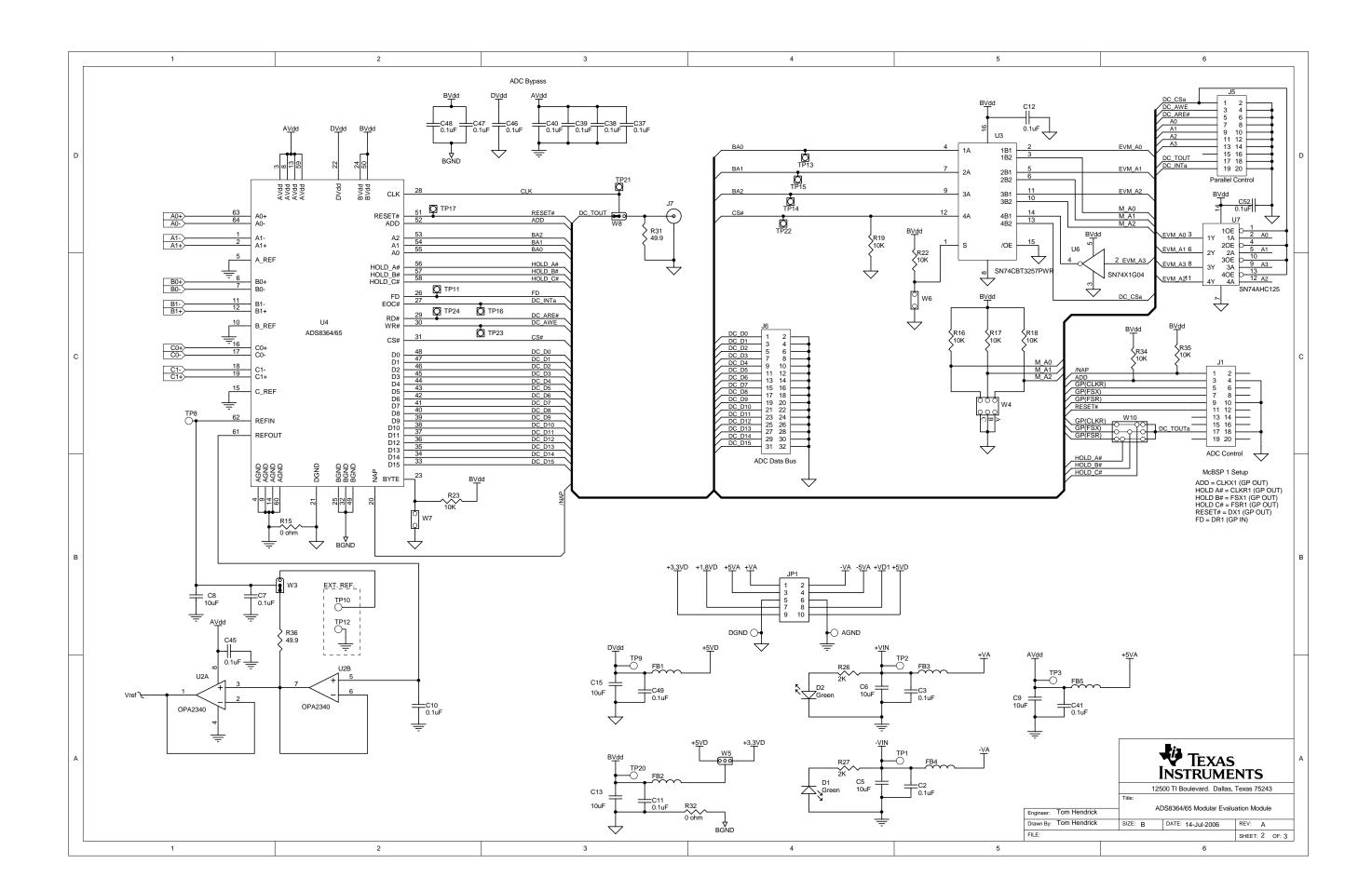


Figure 3. ADS8364/654MEVM Assembly Drawing

7.3 Circuit Schematics

The entire circuit schematic for the ADS8364/65MEVM appears on the following page.







8 Related Documentation From Texas Instruments

- 1. ADS8364, 250kHz, 16-Bit, 6-Channel Simultaneous Sampling Analog-to-Digital Converters data sheet (SBAS219)
- 2. ADS8365, 250kHz, 16-Bit, 6-Channel Simultaneous Sampling Analog-to-Digital Converter data sheet (SBAS362)
- 3. OPA2132, High-Speed FET-Input Operational Amplifiers data sheet (SBOS054)
- 4. INA159, Precision Gain of 0.2 Level Translation Difference Amplifier data sheet (SBOS333)
- 5. 5-6K Interface Board User's Guide (SLAU104)
- 6. DAP Signal Conditioning Board User's Guide (SLAU105)
- 7. ×HPA-MCU Interface Board User's Guide (SLAU106)
- 8. Designing Modular EVMs for Data Acquisition Products application report (SLAA185)
- 9. Data Converters for Industrial Power Management application report (SBAA117)
- 10. Op-Amps for Everyone application report (SLOD006)

10

EVALUATION BOARD/KIT IMPORTANT NOTICE

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT**, **DEMONSTRATION**, **OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user is not exclusive.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit www.ti.com/esh.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT**, **DEMONSTRATION**, **OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of -15 V to +15 V and the output voltage range of 0 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85°C. The EVM is designed to operate properly with certain components above 30°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2006, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Telephony	www.ti.com/telephony
Low Power Wireless	www.ti.com/lpw	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated Free Manuals Download Website

http://myh66.com

http://usermanuals.us

http://www.somanuals.com

http://www.4manuals.cc

http://www.manual-lib.com

http://www.404manual.com

http://www.luxmanual.com

http://aubethermostatmanual.com

Golf course search by state

http://golfingnear.com

Email search by domain

http://emailbydomain.com

Auto manuals search

http://auto.somanuals.com

TV manuals search

http://tv.somanuals.com